ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES international and P	position De IPC, Bannockl an-American co	claration ourn, Illinois. A opyright conver	ll rights reserved untions.	under both	This docume level parts, t	ent is a declaration er	on of the substan	ces within the manufact wer level materials for	turer listed i which the r	item. Note: if nanufacturer l	the item is an as	sembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distrib				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				erials and N	ials and Mfg Information			
upplier Information													
Company name*			Company unique ID			Unique ID Authority				Response Date*			
onsemi										2024-05-02			
Contact Name Title - Conta			lontact			Phone - Contact*			Email -	Email - Contact*			
Product-Env-Stewards Produc			Product Enviro Compliance			NA			Produe	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Rep			Representative			Phone - Representative*			Email -	Email - Representative*			
Product-Env-Stewards Pro			Product Enviro Compliance			NA			Produc	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
	NXH160 SG	NXH160T120L2Q2F2 PIM 1200 SG		1200V, 160A Split TNPC		2024-05-02		CNG		175618.11	mg	Each	
Ianufacturing Proccess Inform	ation												
Terminal Plating / Grid Array M	Aaterial 7	Terminal Base A	Alloy	J-STD-020 MSL Rating		Peak Process Body Temperature Max Time		ature Max Time at Pea	ak Tempera	ture Numbe	r of Reflow Cy	eles	
Matte Tin (Sn) - annealed C		CU Alloy NA		NA		0	С	30	secor	nds 3			
omments													
or more information regarding materia	al composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	10330.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3	2	3615.5	mg
			Supplier	PBT	26062-94-2		6714.4995	mg
Case Lid	6690.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		2341.5	mg
			Supplier	РВТ	26062-94-2		4348.5	mg
DBC	17490.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		6996	mg
			Supplier	Copper (Cu)	7440-50-8		10494	mg
Die	219.105	mg	Supplier	Silicon (Si)	7440-21-3		219.105	mg
Glue	410.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		41	mg
			Supplier	Miscellaneous	Trade Secret		41	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		328	mg
Heat Sink	123450.0	mg	В	Nickel (Ni)	7440-02-0		1913.475	mg
			Supplier	Copper (Cu)	7440-50-8		121536.5234	mg
NTC	10.0	mg	Supplier	Silver (Ag)	7440-22-4		0.0979	mg
			Supplier	Tin (Sn)	7440-31-5		0.02	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		3.9169	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0999	mg
			В	Nickel (Ni)	7440-02-0		0.01	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.3997	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		5.4556	mg
Silicone Gel	8400.0	mg	Supplier	Silica, [(ethenyldimethylsilyl)oxy]- and [(trimethylsilyl)oxy]- modified	68988-89-6		2520	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		5880	mg
Solder Paste	5040.0	mg	Supplier	Silver (Ag)	7440-22-4		327.6	mg
			Supplier	Tin (Sn)	7440-31-5		4712.3999	mg
			Supplier	Copper (Cu)	7440-50-8		-151.2004	mg
Terminal	3540.0	mg	Supplier	Silicon (Si)	7440-21-3		9.558	mg
			В	Nickel (Ni)	7440-02-0		47.79	mg
			Supplier	Copper (Cu)	7440-50-8		3481.7671	mg
			Supplier	Phosphorus (P)	7723-14-0		0.885	mg
Wire Bond - Al	39.0	mg	Supplier	Aluminum (Al)	7429-90-5		39	mg